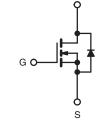


Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	600				
R _{DS(on)} (Ω)	V _{GS} = 10 V	0.60			
Q _g (Max.) (nC)	84				
Q _{gs} (nC)	18				
Q _{gd} (nC)	36				
Configuration	Single				





N-Channel MOSFET

FEATURES

- Ultra Low Gate Charge
- Reduced Gate Drive Requirement
- Enhanced 30 V V_{GS} Rating
- Reduced C_{iss}, C_{oss}, C_{rss}
- · Isolated Central Mounting Hole
- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Lead (Pb)-free Available

DESCRIPTION

This new series of low charge Power MOSFETs achieve significantly lower gate charge over conventional MOSFETs. Utilizing advanced Power MOSFET technology the device improvements allow for reduced gate drive requirements, faster switching speeds and increased total system savings. These device improvements combined with the proven ruggedness and reliability of Power MOSFETs offer the designer a new standard in power transistors for switching applications.

The TO-247 package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220 devices. The TO-247 is similar but superior to the earlier TO-218 package because its isolated mounting hole.

ORDERING INFORMATION	
Package	TO-247
Lead (Pb)-free	IRFPC50LCPbF
	SiHFPC50LC-E3
SnPb	IRFPC50LC
	SiHFPC50LC

ABSOLUTE MAXIMUM RATINGS T	_C = 25 °C, unless otherw	ise noted			
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V _{DS}	600	V	
Gate-Source Voltage	Gate-Source Voltage		± 30	v	
Continuous Drain Current	V_{GS} at 10 V $T_C = 25 \degree C$	1-	11		
	$T_{\rm C} = 100 ^{\circ}{\rm C}$	I _D	7.3	A	
Pulsed Drain Current ^a	I _{DM}	44	1		
Linear Derating Factor			1.5	W/°C	
Single Pulse Avalanche Energy ^b		E _{AS}	920	mJ	
Repetitive Avalanche Current ^a		I _{AR}	11	A	
Repetitive Avalanche Energy ^a		E _{AR}	19	mJ	
Maximum Power Dissipation	T _C = 25 °C	PD	190	W	
Peak Diode Recovery dV/dt ^c		dV/dt	3.0	V/ns	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	0 °	
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^d		
Mounting Torque	6-32 or M3 screw		10	lbf ⋅ in	
Mounting Torque	0-52 OF MIS SCIEW		1.1	N · m	

Notes

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a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 13 mH, $R_G = 25 \Omega$, $I_{AS} = 11 \text{ A}$ (see fig. 12).

c. $I_{SD} \le 11$ A, dI/dt ≤ 100 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply



COMPLIANT

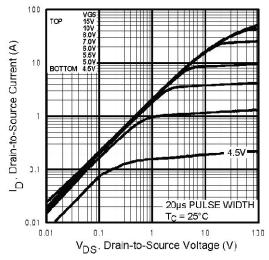


SYMBOL	TYP.						
			MAX.		UNIT		
R _{thJA}	- 40 0.24 - - 0.65						
R _{thCS}				°C/W			
R _{thJC}							
					Γ		
SYMBOL	TEST	CONDITI	ONS	MIN.	TYP.	MAX.	UNIT
-	1				1		1
V _{DS}				600	-	-	V
$\Delta V_{DS}/T_J$	Reference t	o 25 °C,	$I_D = 1 \text{ mA}$	-	0.59	-	V/°C
V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		2.0	-	4.0	V	
I _{GSS}	V _{GS} = ± 20 V		-	-	± 100	nA	
	$V_{DS} = 60$	00 V, V _{G8}	_S = 0 V	-	-	25	
IDSS	V _{DS} = 480 V, V _{GS} = 0 V, T _J = 125 °C	-	-	250	μA		
R _{DS(on)}	V _{GS} = 10 V	ا	_D = 6.6 A ^b	-	-	0.60	Ω
g _{fs}	V _{DS} = 10	0 V, I _D =	6.6 A ^b	7.0	-	-	S
-					I	<u> </u>	
C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	2300	-	pF	
			-	270	-		
			-	28	-		
-				-	-	84	
-	V _{GS} = 10 V		D = 11 A, V _{DS} = 360 V, see fig. 6 and 13 ^b	-	-	18	nC
		see f		_	_	36	
				-	17	-	
	-			-		-	-
	$V_{DD} = 300 \text{ V}, \text{ I}_D = 11 \text{ A},$ $R_0 = 6.2 \text{ O}, R_0 = 30 \text{ O}, \text{ see fig. } 10^{\text{b}}$				_	ns	
		$n_{\rm G} = 0.2 \Omega_2$, $n_{\rm D} = 30 \Omega_2$, see lig. 10-					-
				_	20	-	
L _D	,	m		-	5.0	-	
L _S	package and center of die contact		-	13	-	nH	
ics						•	
I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	11	A	
I _{SM}			-	-	44		
V _{SD}	T _J = 25 °C, Is	_S = 11 A,	V _{GS} = 0 V ^b	-	-	1.4	V
	- T _J = 25 °C, I _F = 11 A, dl/dt = 100 A/μs ^b		_	590	890	ns	
t _{rr}	T 25 °C L -	11 0 414	dt - 100 A/usb	-	590	890	113
t _{rr} Q _{rr}	– T _J = 25 °C, I _F =	11 A, dl/	dt = 100 A/µs ^b	-	4.5	6.8	μC
	RthCS RthJC SYMBOL VDS ΔVDS/TJ VGS(th) IGSS IDSS RDS(on) gfs Ciss Coss Crss Qg Qgd td(on) tr td(onf) tf LD LS IS IS	$\begin{tabular}{ c c c c } \hline $R_{th,CS}$ 0.24 \\ \hline $R_{th,JC}$ - \\ \hline $ $YMBOL$ TEST (1) \\ \hline $ $YMBOL$ TEST (1) \\ \hline $ V_{DS} V_{GS} = 0 \\ \hline $ $\Delta V_{DS}/T_J$ Reference for $ $V_{GS}(th)$ $V_{DS} = V \\ \hline $ $V_{CS}(th)$ $V_{DS} = V \\ \hline $ V_{DS} $V_{GS} = 0 \\ \hline $ $V_{DS} $V_{GS} = 10 \\ \hline $ V_{DS} $V_{GS} = 10 \\ \hline $ V_{DS} $V_{DS} = 10 \\ \hline $ $V_{DD} = 30 \\ \hline $ $R_{G} = 6.2 \Omega, R \\ \hline $ $t_{d}(on)$ t_{f} $V_{DD} = 30 \\ \hline $ $R_{G} = 6.2 \Omega, R \\ \hline $ t_{f} \\ \hline $ L_{D} $Between lead, $6 mm (0.25") fro $ $package and cend $ $circle contact$ $ics \\ \hline $ I_{SM} $p - n junction did $ p - n junction did $	$\begin{tabular}{ c c c c } \hline R_{thJC} 0.24 \\ \hline R_{thJC} - \\ \hline $YMBOL$ TEST CONDITION $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$$	$\begin{tabular}{ c c c c } \hline $R_{th,LC}$ 0.24 & - & 0.65 \\ \hline $R_{th,JC}$ - & 0.65 \\ \hline C, unless otherwise noted \\ \hline $SYMBOL$ TEST CONDITIONS \\ \hline V_{DS} V_{GS} = 0 V, I_D = 250 \ \mu A \\ $\Delta V_{DS}/T_J$ Reference to 25 °C, I_D = 1 mA \\ \hline $V_{GS}(th)$ V_{DS} = V_{GS}, I_D = 250 \ \mu A \\ \hline $V_{GS}(th)$ V_{DS} = V_{GS}, I_D = 250 \ \mu A \\ \hline $V_{GS}(th)$ V_{DS} = 480 \ V, V_{GS} = 0 \ V \\ \hline $V_{DS} = 480 \ V, V_{GS} = 0 \ V, T_J = 125 \ ^{\circ}C \\ \hline $R_{DS}(on)$ V_{GS} = 10 \ V $I_D = 6.6 \ A^b \\ \hline $V_{DS} = 100 \ V, I_D = 6.6 \ A^b \\ \hline $V_{DS} = 25 \ V, $f = 1.0 \ MLz, see fig. 5 \\ \hline Q_{gs} V_{GS} = 10 \ V $I_D = 11 \ A, $V_{DS} = 360 \ V, $see fig. 6 \ and 13^b \\ \hline Q_{gd} \\ \hline t_1 R_G = 6.2 \ \Omega, $R_D = 300 \ V, I_D = 11 \ A, $R_G = 6.2 \ \Omega, $R_D = 300 \ \Omega, $see fig. 10^b$ \\ \hline t_1 \\ \hline L_D Between lead, $6 \ mm (0.25") \ from $package and center of $die $contact$ \\ \hline L_S $MOSFET symbol $showing the $integral reverse $p - n $junction diode$ \\ \hline t_1 M $NOSFET symbol $showing the $integral reverse $p - n $junction diode$ \\ \hline t_1 \\ \hline L_S $Nove $P - n $junction diode$ \\ \hline t_1 \\ \hline L_S $Nove $P - n $junction diode$ \\ \hline t_1 \\ \hline t_2 \\ \hline t_2 \\ \hline t_3 \\ \hline t_2 \\ \hline t_3 \\ \hline t_4 \\ \hline t_5 \\ \hline $	$\begin{tabular}{ c c c c c } \hline $R_{th,UC}$ 0.24 & - & 0.65 \\ \hline $R_{th,UC}$ - & 0.65 \\ \hline $SYMBOL$ TEST CONDITIONS $MIN. \\ \hline V_{DS} V_{GS} = 0 V, I_D = 250 μA $600 \\ $\Delta V_{DS}/T_J$ Reference to 25 °C, I_D = 1 m$A $-$ \\ \hline $V_{GS}(h)$ V_{DS} = V_{GS}, I_D = 250 μA $2.0 \\ \hline I_{GSS} V_{GS} = \pm 20 V $-$ \\ \hline $V_{DS} = 600 $V, V_{GS} = 0 V $-$ \\ \hline $V_{DS} = 480 $V, V_{GS} = 0 V $-$ \\ \hline $V_{DS} = 480 $V, V_{GS} = 0 V $-$ \\ \hline $V_{DS} = 480 $V, V_{GS} = 0 V $-$ \\ \hline $V_{DS} = 480 $V, V_{GS} = 0 V $-$ \\ \hline $V_{DS} = 480 $V, V_{GS} = 0 V $-$ \\ \hline $V_{DS} = 480 $V, V_{GS} = 0 V $-$ \\ \hline $V_{DS} = 100 V $I_D = 6.6 A^b $-$ \\ \hline Q_{gs} $V_{GS} = 10 V $I_D = 6.6 A^b $-$ \\ \hline C_{rss} $V_{GS} = 10 V $I_D = 6.6 A^b $-$ \\ \hline C_{rss} $V_{GS} = 10 V $I_D = 5.6 A^b $-$ \\ \hline C_{rss} $V_{GS} = 10 V $I_D = 5.6 A^b $-$ \\ \hline C_{rss} $V_{GS} = 10 V $I_D = 5.6 A^b $-$ \\ \hline C_{rss} $V_{GS} = 10 V $I_D = 11 A, $V_{DS} = 360 V, $-$ \\ \hline C_{rss} $V_{GS} = 10 V $I_D = 11 A, $V_{DS} = 360 V, $-$ \\ \hline C_{rss} $V_{GS} = 10 V $I_D = 300 V, $I_D = 11 A, $-$ \\ \hline C_{rss} $V_{GS} = 10 V $I_D = 300 V, $I_D = 11 A, $-$ \\ \hline C_{rss} $V_{GS} = 10 V $I_D = 300 V, $I_D = 11 A, $-$ \\ \hline C_{rss} $V_{DD} = 300 V, $I_D = 11 A, $-$ \\ \hline C_{rss} $V_{DD} = 300 V, $I_D = 11 A, $-$ \\ \hline C_{rss} $V_{DD} = 300 V, $I_D = 11 A, $-$ \\ \hline C_{rss} $V_{DD} = 300 V, $I_D = 11 A, $-$ \\ \hline C_{rss} $V_{DD} = 300 V, $I_D = 11 A, $-$ \\ \hline C_{rss} $V_{DD} = 300 V, $I_D = 11 A, $-$ \\ \hline C_{rss} $V_{DD} = 300 V, $I_D = 11 A, $-$ \\ \hline C_{rss} $V_{DD} = 300 V, $I_D = 11 A, $-$ \\ \hline C_{rss} $V_{DD} = 300 V, $I_D = 11 A, $-$ \\ \hline C_{rss} $V_{DD} = 300 V, $I_D = 11 A, $-$ \\ \hline C_{rss} $V_{DD} = 300 V, $I_D = 11 A, $-$ \\ \hline C_{rss} $V_{DD} = 300 V, $V_{DS} = 0 V, V	$\begin{tabular}{ c c c c c } \hline $P_{lh,CS} & 0.24 & - & & & & & & & & & & & & & & & & & $	$\begin{tabular}{ c c c c c } \hline $\mathbf{R}_{th_{JC}}$ & 0.24 & $-$ & 0.65 \\ \hline $\mathbf{R}_{th_{JC}}$ & $-$ & 0.65 \\ \hline \mathbf{SYMBOL} & $\mathbf{TEST CONDITIONS}$ & \mathbf{MIN} & \mathbf{TYP} & \mathbf{MAX} \\ \hline \mathbf{V}_{DS} & $\mathbf{V}_{GS} = 0 \ V, \ I_{D} = 250 \ \mu A$ & 600 & $-$ & $-$ & 0.59 & $-$ \\ \hline $\Delta V_{DS}/T_J$ & \mathbf{R} efference to $25 \ ^\circ C, \ I_{D} = 1 \ m A$ & $-$ & 0.59 & $-$ \\ \hline $V_{GS}(m)$ & $V_{DS} = V_{GS}, \ I_{D} = 250 \ \mu A$ & 2.0 & $-$ & $-$ & 250 \\ \hline V_{DS} & $V_{GS} = 400$ V, \ V_{GS} = 0$ V$ & $-$ & $-$ & 250 \\ \hline V_{DS} & $V_{DS} = 480$ V, \ V_{GS} = 0$ V$ & $-$ & $-$ & 250 \\ \hline V_{DS} & 480 V, \ V_{GS} = 0$ V$ & $-$ & $-$ & 250 \\ \hline V_{DS} & 480 V, \ V_{GS} = 0$ V$ & $-$ & $-$ & 250 \\ \hline V_{DS} & 480 V, \ V_{GS} = 0$ V$ & $-$ & $-$ & 250 \\ \hline V_{DS} & 480 V, \ V_{GS} = 0$ V$ & $-$ & $-$ & 250 \\ \hline V_{DS} & 480 V, \ V_{GS} = 0$ V$ & $-$ & $-$ & 250 \\ \hline V_{DS} & 480 V, \ V_{GS} = 0$ V$ & $-$ & $-$ & 250 \\ \hline V_{DS} & 480 V, \ V_{GS} = 0$ V$ & $-$ & $-$ & 250 \\ \hline V_{DS} & $-$ & 0.66 \\ \hline g_{1s} & $V_{DS} = 10$ V$ & $I_{D} = 6.6$ \ A^{D}$ & $-$ & $-$ & 280 \\ \hline V_{Crss} & $V_{CS} = 10$ V$ & $I_{D} = 6.6$ \ A^{D}$ & $-$ & $-$ & 280 \\ \hline V_{Crss} & $V_{DS} = 10$ V$ & $I_{D} = 6.6$ \ A^{D}$ & $-$ & $-$ & 28 \\ \hline $V_{GS} = 10$ V$ & $I_{D} = 6.6$ \ A^{D}$ & $-$ & $-$ & 28 \\ \hline V_{Crss} & $V_{CS} = 10$ V$ & $I_{D} = 6.6$ \ A^{D}$ & $-$ & $-$ & 28 \\ \hline V_{Crss} & $V_{CS} = 10$ V$ & $I_{D} = 11$ \ A,$ $V_{DS} = 360$ V$ \\ \hline $v_{DD} = 300$ V$, \ I_{D} = 11$ \ A,$ $V_{DS} = 360$ V$ \\ \hline $v_{DD} = 300$ V$, \ I_{D} = 11$ \ A,$ $V_{CS} = 360$ V$ \\ \hline $v_{DD} = 300$ V$, \ I_{D} = 11$ \ A,$ $V_{CS} = 10$ V$ \\ \hline $V_{DD} = 300$ V$, \ I_{D} = 11$ \ A,$ $V_{CS} = 10$ V$ \\ \hline $v_{DD} = 300$ V$, \ I_{D} = 11$ \ A,$ $V_{CS} = 0$ \\ \hline $v_{DD} = $V_{DD} $ & $v_{DS} = 10$ \ V$ \\ \hline $v_{DD} = 300$ V$, \ I_{D} = 11$ \ A,$ $V_{CS} = 0$ \\ \hline $v_{DD} = $V_{DD} $ & $v_{DS} = 10$ \ V$ \\ \hline $v_{DD} = $V_{DD} $ & $v_{DS} = 10$ \ V$ \\ \hline $v_{DD} = $V_{DD} $ & $v_{DS} = 10$ \ V$ \\ \hline $v_$

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width \leq 300 µs; duty cycle \leq 2 %.





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Fig. 1 - Typical Output Characteristics, $T_C = 25$ °C

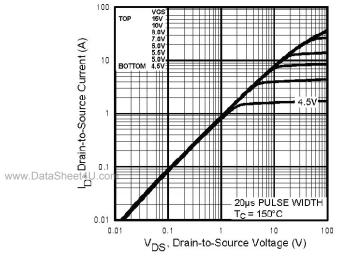


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

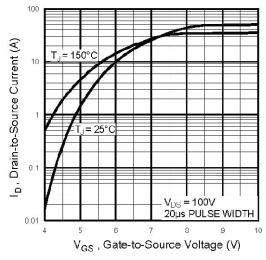


Fig. 3 - Typical Transfer Characteristics

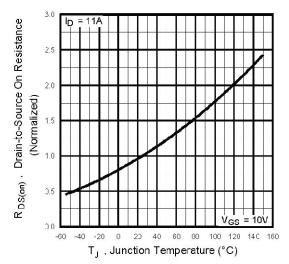


Fig. 4 - Normalized On-Resistance vs. Temperature

IRFPC50LC, SiHFPC50LC

Vishay Siliconix



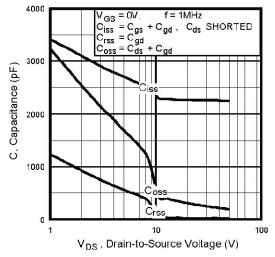


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

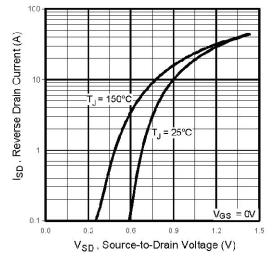


Fig. 7 - Typical Source-Drain Diode Forward Voltage

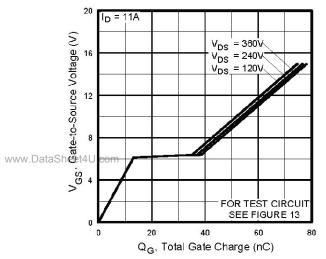


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

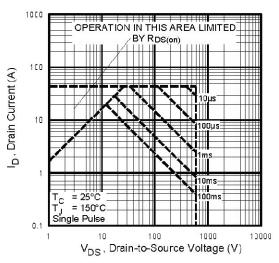
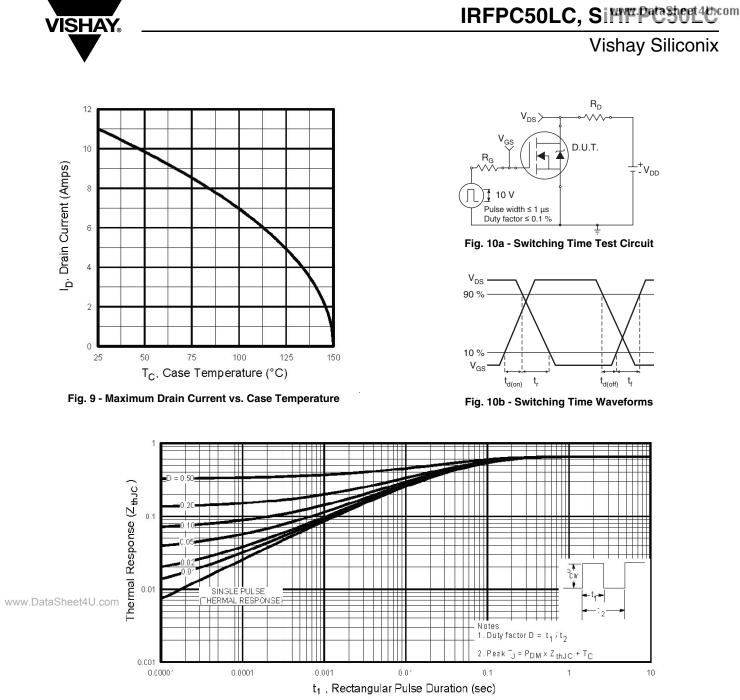


Fig. 8 - Maximum Safe Operating Area





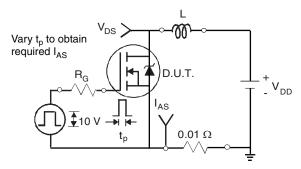


Fig. 12a - Unclamped Inductive Test Circuit

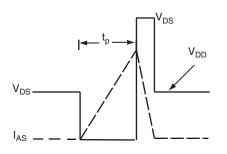


Fig. 12b - Unclamped Inductive Waveforms

IRFPC50LC, SiHFPC50LC

Vishay Siliconix



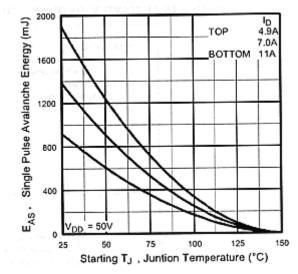
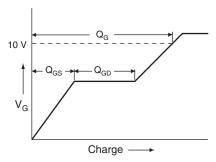
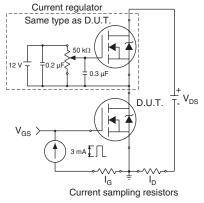


Fig. 12c - Maximum Avalanche Energy vs. Drain Current



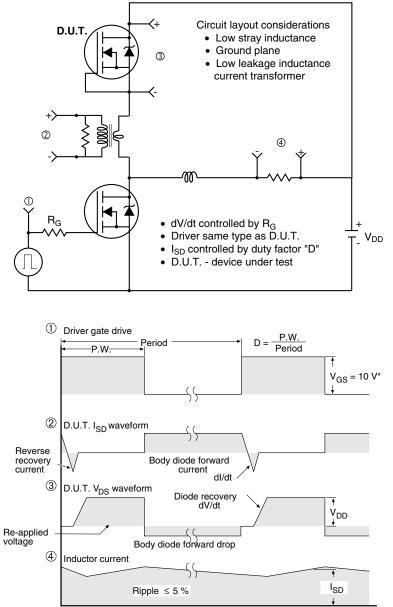


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Fig. 13a - Basic Gate Charge Waveform







Peak Diode Recovery dV/dt Test Circuit

* $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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